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PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
TAKASHI USHIDA	03/14/2019
KATSUKO FURUKAWA	03/14/2019
SEIZI NISHIZAWA	03/19/2019

RECEIVING PARTY DATA

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State/Country:	JAPAN
1	

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	16091531

CORRESPONDENCE DATA

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PATENT 505585093 REEL: 049833 FRAME: 0858

DATE SIGNED: 07/23/2019

Total Attachments: 2
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source=11498US01AssignmentforFiling#page2.tif

PATENT REEL: 049833 FRAME: 0859

PATENT ASSIGNMENT

ASSIGNOR(S): (Insert Inventor(s) name, city/state, country of residence
ASSIGNOR(S). (Insert inventor(s) name, city/state, country of residence
Takashi USHIDA, Ibaraki, Japan
Katsuko FURUKAWA, Tokyo, Japan
Seizi NISHIZAWA, Tokyo, Japan

PARTIES TO THE ASSIGNMENT

ASSIGNEE(S): (Insert Companies or Assignee(s) Name and Address)

ADVANCED BIO-SPECTROSCOPY CO., LTD of D-305, Keiei Support Kan, Incubation Office TAMA, Tokyo S&M Enterprise Support Center, 3-6-1, Azumacho, Akishima-shi, Tokyo 1960033 Japan, and THE UNIVERSITY OF TOKYO of 7-3-1, Hongo, Bunkyo-ku, Tokyo 1138654 Japan

Agreement

Whereas, ASSIGNOR(S) listed above, are inventor(s) of an invention entitled <u>METHOD FOR</u>

OBSERVING DYNAMIC PHYSICAL PROPERTY OF BIOLOGICAL TISSUE AND DEVICE FOR

OBSERVING DYNAMIC PHYSICAL PROPERTY OF BIOLOGICAL TISSUE

(title of invention), Application No. <u>16/091</u>, 531_, filed <u>October 5</u>, 2018_,

ASSIGNOR(S) hereby authorizes and requests ASSIGNEE'S legal representatives, of Xsensus, LLP, associated with Customer No. 154930, the power to insert on this assignment any further identification, including the application number and filing date, which may be necessary or desirable in order to comply with the rules of the United States Patent and Trademark Office for recordation of this document.

WHEREAS, ASSIGNEE(S), is desirous of acquiring the entire right, title and interest in and to the Invention and in and to any letters patent that may be granted therefor in the United States and in any and all foreign countries:

NOW, THEREFORE, in exchange for good and valuable consideration, the receipt of which is hereby acknowledged, ASSIGNOR(S) hereby sell, assign and transfer unto ASSIGNEE(S) its successors and assigns, the entire right, title and interest in and to said Invention and any improvements thereto, said Application and any and all letters patent which may be granted for said Invention in the United States of America and its territorial possessions and in any and all foreign countries, and in any and all provisional, divisions, reissues, re-examinations and continuations thereof, including the right to file foreign applications directly in the name of ASSIGNEE(S) and to claim priority rights deriving from said application to which said foreign applications are entitled by virtue of international convention, treaty or otherwise, said invention, application and all letters patent on said Invention to be held and enjoyed by ASSIGNEE(S) and its successors and assigns as fully and entirely as the same would have been held and enjoyed by ASSIGNOR(S) had this assignment, transfer and sale not been made, ASSIGNOR(S) hereby authorize and request the Commissioner of Patents and Trademarks to issue all letters patent on said Invention to ASSIGNEE(S). ASSIGNOR(S) agree to

execute all instruments and documents required for the making and prosecution of applications for United States and foreign letters patent on said Invention, for litigation regarding said letters patent, or for the purpose of protecting title to said Invention or letters patent therefor.

AND ASSIGNOR(S) DOES HEREBY sell, assign, transfer, and convey to ASSIGNEE(S), its successors, legal representatives, and assigns all claims for damages and all remedies arising out of any violation of the rights assigned hereby that may have accrued prior to the date of assignment to ASSIGNEE(S), or may accrue hereafter, including, but not limited to, the right to sue for, collect, and retain damages for past infringements of said letters patent before or after issuance,

AND ASSIGNOR(S) DOES HEREBY covenant and agree that ASSIGNOR(S) will communicate to said ASSIGNEE(S), its successors, legal representatives and assigns, any facts known to ASSIGNOR(S) respecting the Invention or said application, and testify in any legal proceeding, assist in the preparation of any other patent document relating to the application and the Invention or any improvements made thereto, sign/execute all lawful papers, provide all requested documents, execute and make all rightful oaths and/or declarations in connection, with the application and the Invention including any improvements made thereto, any patent applications filed therefrom, and any continuing application filed from any of the aforementioned applications, and generally do everything possible to aid the ASSIGNEE(S), its successors, legal representatives and assigns, to obtain and enforce proper patent protection for the Invention in the United States, its territories, and all foreign countries. These provisions are binding upon our heirs, legal representatives, administrators, and assigns.

(Signature of Inventor) Takashi USHIDA	Date: March 14,2015
Fuhan	Date: March (4 Lo19
(Signature of Inventor) Katsuko FURUKAWA (Signature of Inventor) Seizi NISHIZAWA	Date: MAR. 19. 2019
(Signature of Inventor)	Date:
(Signature of Inventor)	Date:
(Signature of Inventor)	Date: